

# High Voltage Thyristor \ Diode Module

$$V_{RRM} = 2 \times 2000 \text{ V}$$

$$I_{TAV} = 250 \text{ A}$$

$$V_T = 1,03 \text{ V}$$

Phase leg

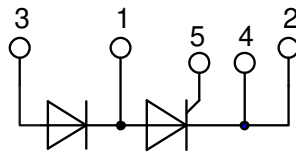
Part number

**MCD224-20io1**



Backside: isolated

 E72873



## Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al<sub>2</sub>O<sub>3</sub>-ceramic

## Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

## Package: Y1

- Isolation Voltage: 4800 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: Copper internally DCB isolated
- Advanced power cycling

## Disclaimer Notice

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| Rectifier      |  |   | Ratings                 |      |       |                   |
|----------------|--|---|-------------------------|------|-------|-------------------|
| Symbol         | Definition   | Conditions  | min.                    | typ. | max.  | Unit              |
| $V_{RSM/DSM}$  | max. non-repetitive reverse/forward blocking voltage | $T_{VJ} = 25^{\circ}C$  |                         |      | 2100  | V                 |
| $V_{RRM/DRM}$  | max. repetitive reverse/forward blocking voltage     | $T_{VJ} = 25^{\circ}C$  |                         |      | 2000  | V                 |
| $I_{RD}$       | reverse current, drain current                       | $V_{R/D} = 2000\text{ V}$   | $T_{VJ} = 25^{\circ}C$  |      | 1     | mA                |
|                |  | $V_{R/D} = 2000\text{ V}$   | $T_{VJ} = 140^{\circ}C$ |      | 40    | mA                |
| $V_T$          | forward voltage drop                                 | $I_T = 250\text{ A}$  | $T_{VJ} = 25^{\circ}C$  |      | 1,08  | V                 |
|                |  | $I_T = 500\text{ A}$  |                         |      | 1,31  | V                 |
|                |  | $I_T = 250\text{ A}$  | $T_{VJ} = 125^{\circ}C$ |      | 1,03  | V                 |
|                |  | $I_T = 500\text{ A}$  |                         |      | 1,33  | V                 |
| $I_{TAV}$      | average forward current                              | $T_C = 85^{\circ}C$   | $T_{VJ} = 140^{\circ}C$ |      | 250   | A                 |
| $I_{T(RMS)}$   | RMS forward current                                  | 180° sine   |                         |      | 390   | A                 |
| $V_{T0}$       | threshold voltage                                    | } for power loss calculation only   | $T_{VJ} = 140^{\circ}C$ |      | 0,72  | V                 |
| $r_T$          | slope resistance                                     |   |                         |      | 1,2   | mΩ                |
| $R_{thJC}$     | thermal resistance junction to case                  |   |                         |      | 0,139 | K/W               |
| $R_{thCH}$     | thermal resistance case to heatsink                  |   |                         | 0,04 |       | K/W               |
| $P_{tot}$      | total power dissipation                              |   | $T_C = 25^{\circ}C$     |      | 820   | W                 |
| $I_{TSM}$      | max. forward surge current                           | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 45^{\circ}C$  |      | 8,00  | kA                |
|                |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$   | $V_R = 0\text{ V}$      |      | 8,64  | kA                |
|                |  | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 140^{\circ}C$ |      | 6,80  | kA                |
|                |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$   | $V_R = 0\text{ V}$      |      | 7,35  | kA                |
| $I^2t$         | value for fusing                                     | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 45^{\circ}C$  |      | 320,0 | kA <sup>2</sup> s |
|                |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$   | $V_R = 0\text{ V}$      |      | 310,5 | kA <sup>2</sup> s |
|                |  | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 140^{\circ}C$ |      | 231,2 | kA <sup>2</sup> s |
|                |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$   | $V_R = 0\text{ V}$      |      | 224,4 | kA <sup>2</sup> s |
| $C_J$          | junction capacitance                                 | $V_R = 700\text{ V}$ $f = 1\text{ MHz}$   | $T_{VJ} = 25^{\circ}C$  |      | 235   | pF                |
| $P_{GM}$       | max. gate power dissipation                          | $t_p = 30\text{ }\mu\text{s}$   | $T_C = 140^{\circ}C$    |      | 120   | W                 |
|                |  | $t_p = 500\text{ }\mu\text{s}$  |                         |      | 60    | W                 |
| $P_{GAV}$      | average gate power dissipation                       |   |                         |      | 20    | W                 |
| $(di/dt)_{cr}$ | critical rate of rise of current                     | $T_{VJ} = 125^{\circ}C; f = 50\text{ Hz}$ repetitive, $I_T = 750\text{ A}$  |                         |      | 100   | A/ $\mu\text{s}$  |
|                |  | $t_p = 200\text{ }\mu\text{s}; di_G/dt = 1\text{ A}/\mu\text{s};$<br>$I_G = 1\text{ A}; V_D = \frac{2}{3} V_{DRM}$ non-repet., $I_T = 250\text{ A}$                     |                         |      | 500   | A/ $\mu\text{s}$  |
| $(dv/dt)_{cr}$ | critical rate of rise of voltage                     | $V_D = \frac{2}{3} V_{DRM}$<br>$R_{GK} = \infty$ ; method 1 (linear voltage rise)   | $T_{VJ} = 125^{\circ}C$ |      | 1000  | V/ $\mu\text{s}$  |
| $V_{GT}$       | gate trigger voltage                                 | $V_D = 6\text{ V}$  | $T_{VJ} = 25^{\circ}C$  |      | 2     | V                 |
|                |  |   | $T_{VJ} = -40^{\circ}C$ |      | 3     | V                 |
| $I_{GT}$       | gate trigger current                                 | $V_D = 6\text{ V}$  | $T_{VJ} = 25^{\circ}C$  |      | 150   | mA                |
|                |  |   | $T_{VJ} = -40^{\circ}C$ |      | 220   | mA                |
| $V_{GD}$       | gate non-trigger voltage                             | $V_D = \frac{2}{3} V_{DRM}$   | $T_{VJ} = 140^{\circ}C$ |      | 0,25  | V                 |
| $I_{GD}$       | gate non-trigger current                             |   |                         |      | 10    | mA                |
| $I_L$          | latching current                                     | $t_p = 30\text{ }\mu\text{s}$   | $T_{VJ} = 25^{\circ}C$  |      | 200   | mA                |
|                |  | $I_G = 0,45\text{ A}; di_G/dt = 0,45\text{ A}/\mu\text{s}$  |                         |      |       |                   |
| $I_H$          | holding current                                      | $V_D = 6\text{ V}$ $R_{GK} = \infty$  | $T_{VJ} = 25^{\circ}C$  |      | 150   | mA                |
| $t_{gd}$       | gate controlled delay time                           | $V_D = \frac{1}{2} V_{DRM}$   | $T_{VJ} = 25^{\circ}C$  |      | 2     | $\mu\text{s}$     |
|                |  | $I_G = 0,5\text{ A}; di_G/dt = 0,5\text{ A}/\mu\text{s}$  |                         |      |       |                   |
| $t_q$          | turn-off time  | $V_R = 100\text{ V}; I_T = 250\text{ A}; V_D = \frac{2}{3} V_{DRM}$<br>$di/dt = 10\text{ A}/\mu\text{s}; dv/dt = 50\text{ V}/\mu\text{s}; t_p = 200\text{ }\mu\text{s}$ | $T_{VJ} = 125^{\circ}C$ |      | 350   | $\mu\text{s}$     |



| Package Y1    |  |                      | Ratings |      |      |      |
|---------------|--|----------------------|---------|------|------|------|
| Symbol        | Definition   | Conditions           | min.    | typ. | max. | Unit |
| $I_{RMS}$     | RMS current  | per terminal         |         |      | 600  | A    |
| $T_{VJ}$      | virtual junction temperature                                 |                      | -40     |      | 140  | °C   |
| $T_{op}$      | operation temperature  |                      | -40     |      | 125  | °C   |
| $T_{stg}$     | storage temperature  |                      | -40     |      | 125  | °C   |
| <b>Weight</b> |  |                      |         | 680  |      | g    |
| $M_D$         | mounting torque  |                      | 4,5     |      | 7    | Nm   |
| $M_T$         | terminal torque  |                      | 11      |      | 13   | Nm   |
| $d_{Spp/App}$ | creepage distance on surface   striking distance through air | terminal to terminal | 16,0    |      |      | mm   |
| $d_{Spb/Apb}$ |  | terminal to backside | 16,0    |      |      | mm   |
| $V_{ISOL}$    | isolation voltage  | t = 1 second         | 4800    |      |      | V    |
|               |  | t = 1 minute         | 4000    |      |      | V    |



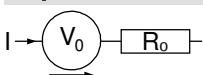
Data Matrix: part no. (1-19), DC + PI (20-25), lot.no.# (26-31), blank (32), serial no.# (33-36)

| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | MCD224-20io1    | MCD224-20io1       | Box           | 3        | 481238   |

**Equivalent Circuits for Simulation**

\* on die level

$T_{VJ} = 140^{\circ}C$

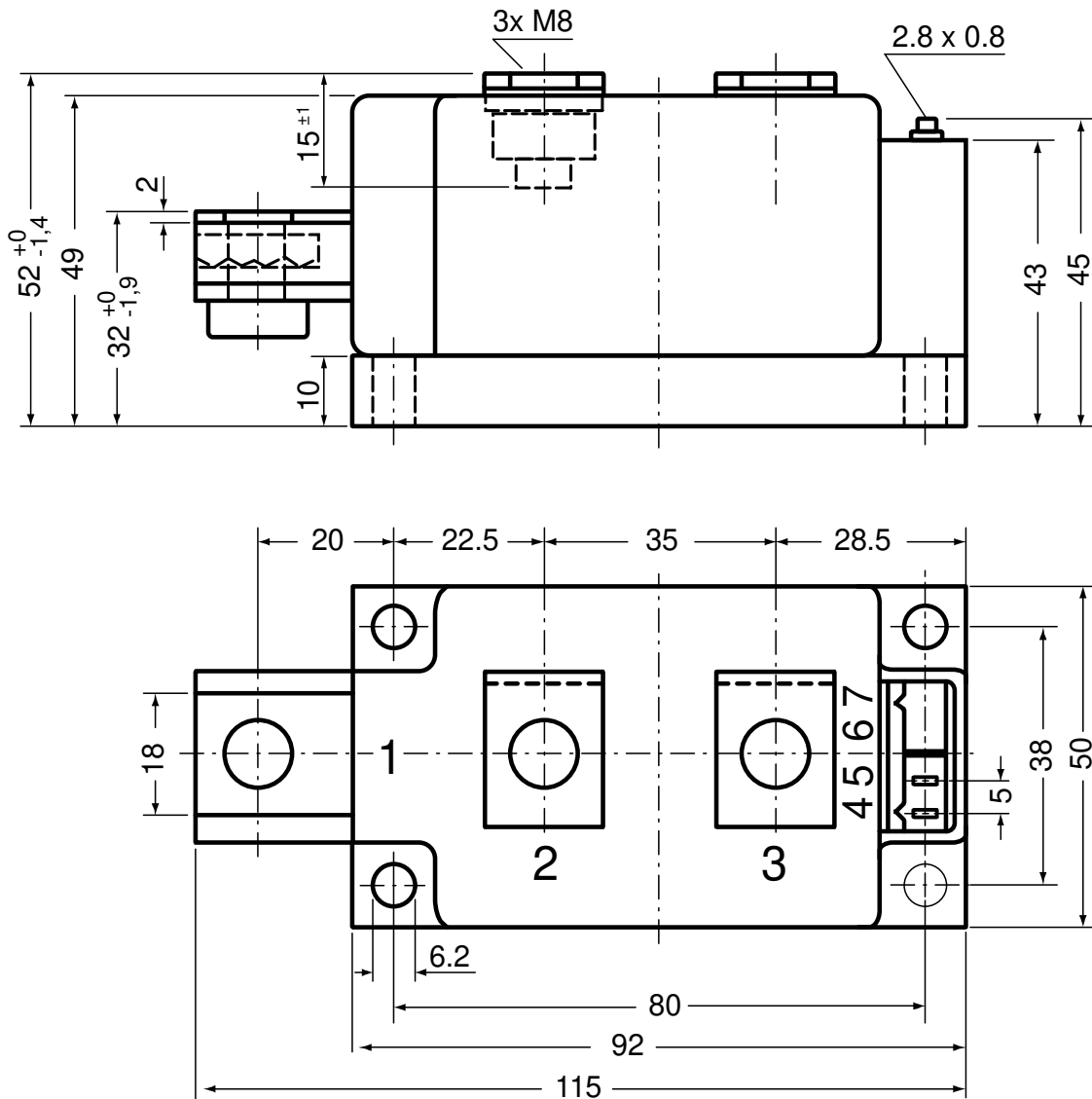


**Thyristor**

|              |                    |      |    |
|--------------|--------------------|------|----|
| $V_{0\ max}$ | threshold voltage  | 0,72 | V  |
| $R_{0\ max}$ | slope resistance * | 1,01 | mΩ |

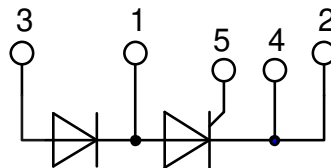


**Outlines Y1**



**Optional accessories for modules**

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red  
Type ZY 180L (L = Left for pin pair 4/5) UL 758, style 3751





**Thyristor**

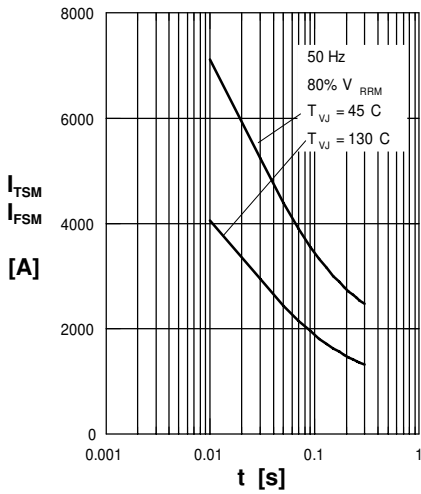


Fig. 1 Surge overload current  
 $I_{T(F)SM}$ : crest value,  $t$ : duration

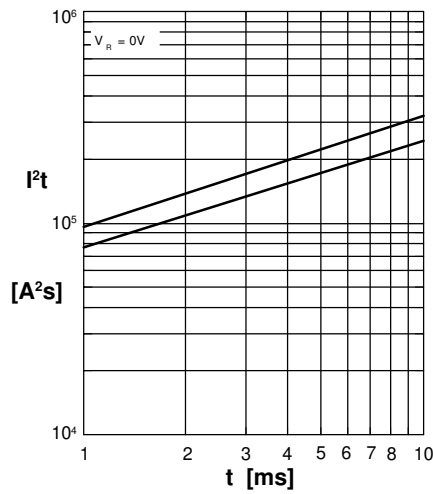


Fig. 2  $I^2t$  versus time (1-10 ms)

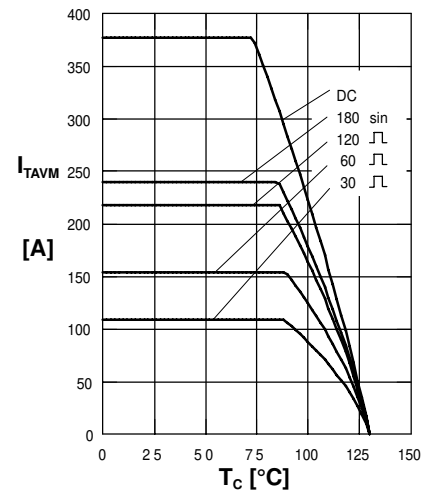


Fig. 3 Max. forward current at case temperature

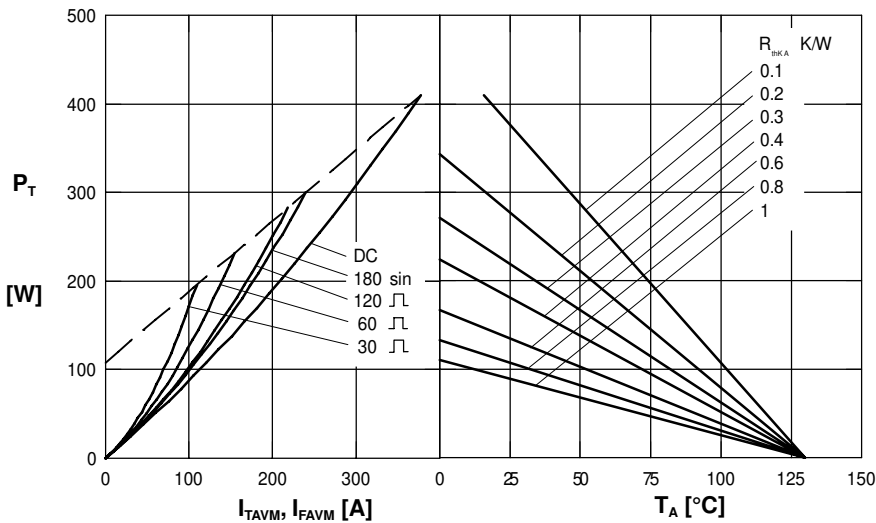


Fig. 4 Power dissipation versus onstate current and ambient temperature (per thyristor/diode)

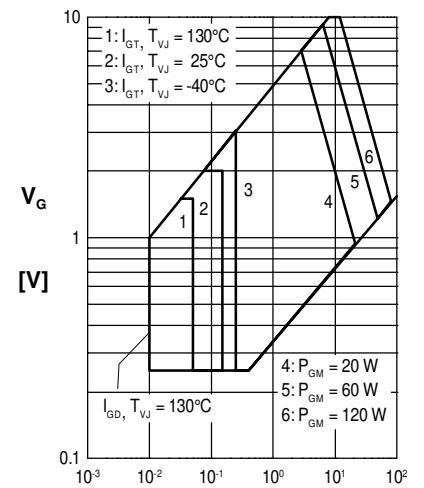


Fig. 5 Gate trigger characteristics

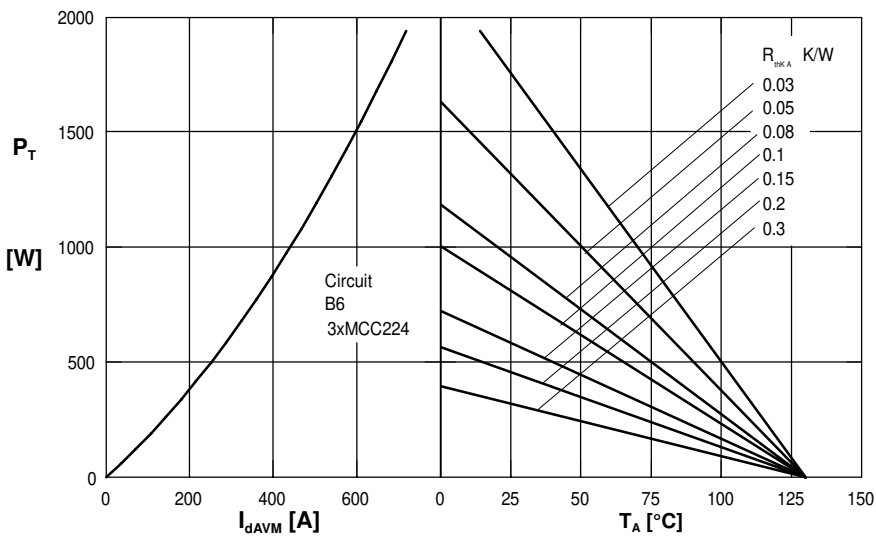


Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

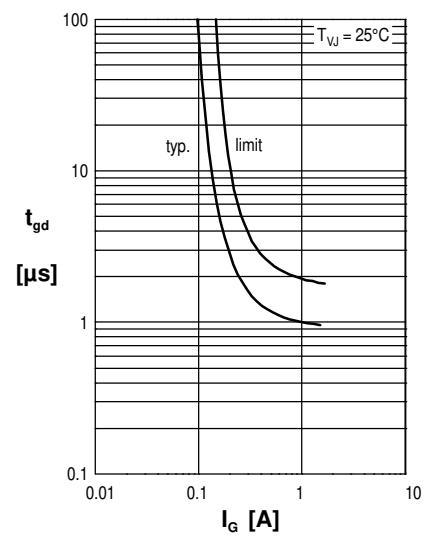


Fig. 7 Gate trigger delay time



**Rectifier**

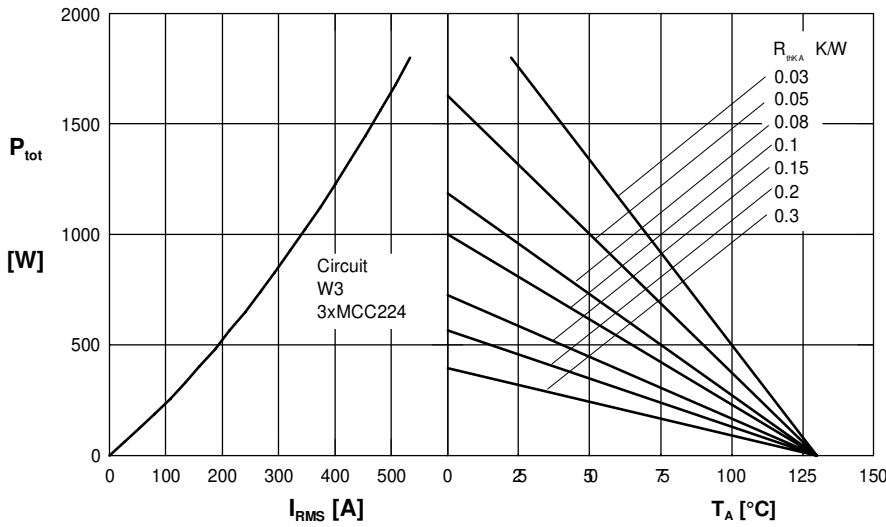


Fig. 7 Three phase AC-controller: Power dissipation versus RMS output current and ambient temperature

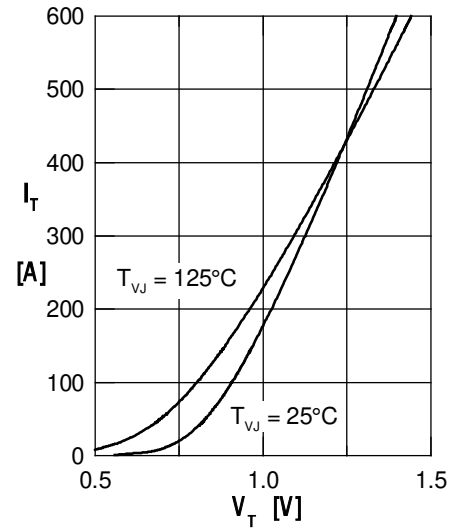


Fig. 10 Forward characteristics

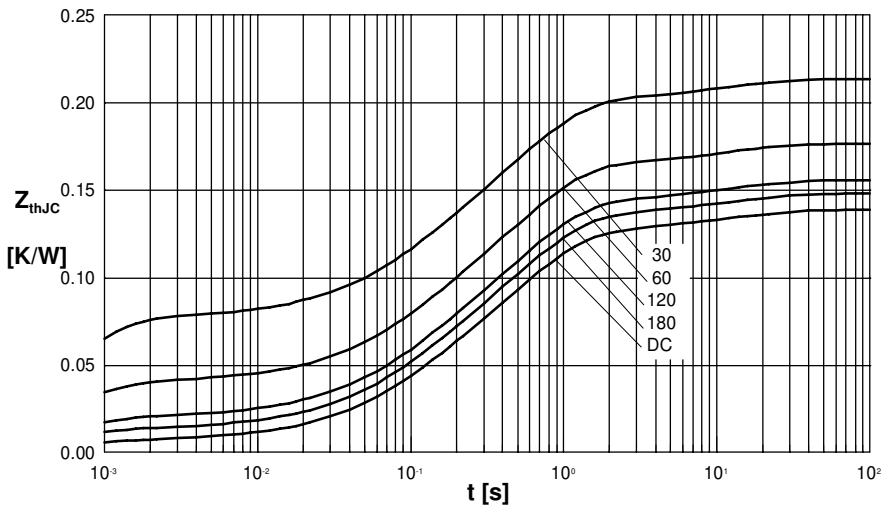


Fig. 8 Transient thermal impedance junction to case (per thyristor/diode)

$R_{thJC}$  for various conduction angles  $d$ :

| $d$   | $R_{thJC}$ [K/W] |
|-------|------------------|
| DC    | 0.139            |
| 180°C | 0.148            |
| 120°C | 0.156            |
| 60°C  | 0.176            |
| 30°C  | 0.214            |

Constants for  $Z_{thJC}$  calculation:

| $i$ | $R_{thi}$ [K/W] | $t_i$ [s] |
|-----|-----------------|-----------|
| 1   | 0.0067          | 0.00054   |
| 2   | 0.0358          | 0.098     |
| 3   | 0.0832          | 0.540     |
| 4   | 0.0129          | 12.00     |

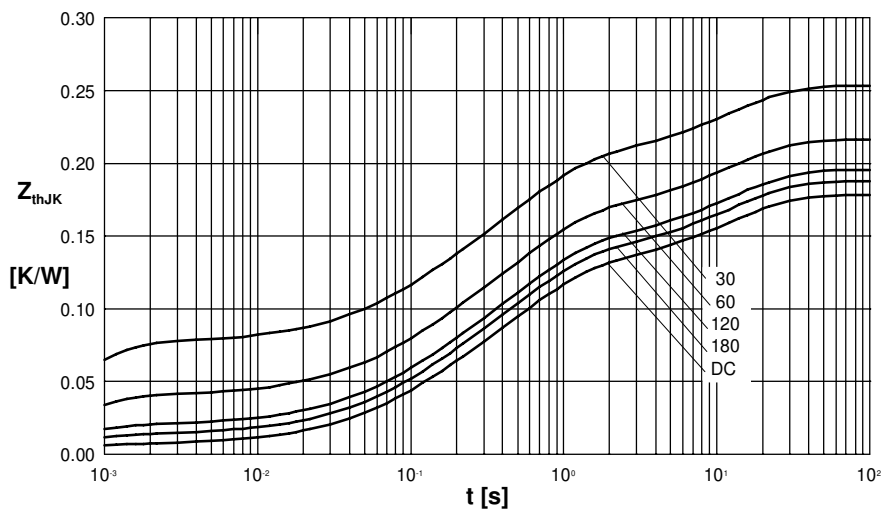


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor/diode)

$R_{thJK}$  for various conduction angles  $d$ :

| $d$   | $R_{thJK}$ [K/W] |
|-------|------------------|
| DC    | 0.179            |
| 180°C | 0.188            |
| 120°C | 0.196            |
| 60°C  | 0.216            |
| 30°C  | 0.256            |

Constants for  $Z_{thJK}$  calculation:

| $i$ | $R_{thi}$ [K/W] | $t_i$ [s] |
|-----|-----------------|-----------|
| 1   | 0.0067          | 0.001     |
| 2   | 0.0358          | 0.080     |
| 3   | 0.0832          | 0.200     |
| 4   | 0.0129          | 1.000     |